E·XFL



Welcome to <u>E-XFL.COM</u>

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	24MHz
Connectivity	I ² C, IrDA, LINbus, Microwire, SmartCard, SPI, SSP, UART/USART
Peripherals	Brown-out Detect/Reset, CapSense, LCD, LVD, POR, PWM, WDT
Number of I/O	31
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.71V ~ 5.5V
Data Converters	A/D 8x12b SAR; D/A 2xIDAC
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	35-UFBGA, WLCSP
Supplier Device Package	35-WLCSP (3.23x2.10)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c4125fni-483t

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



More Information

Cypress provides a wealth of data at www.cypress.com to help you to select the right PSoC device for your design, and to help you to quickly and effectively integrate the device into your design. For a comprehensive list of resources, see the knowledge base article KBA86521, How to Design with PSoC 3, PSoC 4, and PSoC 5LP. Following is an abbreviated list for PSoC 4:

- Overview: PSoC Portfolio, PSoC Roadmap
- Product Selectors: PSoC 1, PSoC 3, PSoC 4, PSoC 5LP In addition, PSoC Creator includes a device selection tool.
- Application notes: Cypress offers a large number of PSoC application notes covering a broad range of topics, from basic to advanced level. Recommended application notes for getting started with PSoC 4 are:
 - □ AN79953: Getting Started With PSoC 4
 - □ AN88619: PSoC 4 Hardware Design Considerations
 - □ AN86439: Using PSoC 4 GPIO Pins
 - □ AN57821: Mixed Signal Circuit Board Layout
 - AN81623: Digital Design Best Practices
 - AN73854: Introduction To Bootloaders
 - AN89610: ARM Cortex Code Optimization
 - □ AN90071: CY8CMBRxxx CapSense Design Guide

- Technical Reference Manual (TRM) is in two documents:
- Architecture TRM details each PSoC 4 functional block.
- Registers TRM describes each of the PSoC 4 registers.
- Development Kits:
 - CY8CKIT-042, PSoC 4 Pioneer Kit, is an easy-to-use and inexpensive development platform. This kit includes connectors for Arduino[™] compatible shields and Digilent® Pmod[™] daughter cards.
 - CY8CKIT-049 is a very low-cost prototyping platform. It is a low-cost alternative to sampling PSoC 4 devices.
 - CY8CKIT-001 is a common development platform for any one of the PSoC 1, PSoC 3, PSoC 4, or PSoC 5LP families of devices.

The MiniProg3 device provides an interface for flash programming and debug.

PSoC Creator

PSoC Creator is a free Windows-based Integrated Design Environment (IDE). It enables concurrent hardware and firmware design of PSoC 3, PSoC 4, and PSoC 5LP based systems. Create designs using classic, familiar schematic capture supported by over 100 pre-verified, production-ready PSoC Components; see the list of component datasheets. With PSoC Creator, you can:

- 1. Drag and drop component icons to build your hardware system design in the main design workspace
- 2. Codesign your application firmware with the PSoC hardware, using the PSoC Creator IDE C compiler
- 3. Configure components using the configuration tools
- 4. Explore the library of 100+ components
- 5. Review component datasheets

Figure 1. Multiple-Sensor Example Project in PSoC Creator





Contents

Functional Definition	5
CPU and Memory Subsystem	5
System Resources	5
Analog Blocks	6
Fixed Function Digital	7
GPIO	7
Special Function Peripherals	8
Pinouts	9
Power	15
Unregulated External Supply	15
Regulated External Supply	16
Development Support	17
Documentation	17
Online	17
Tools	17
Electrical Specifications	18
Absolute Maximum Ratings	18
Device-Level Specifications	18

Analog Peripherals	22
Digital Peripherals	26
Memory	29
System Resources	29
Ordering Information	32
Part Numbering Conventions	33
Packaging	34
Acronyms	38
Document Conventions	40
Units of Measure	40
Revision History	41
Sales, Solutions, and Legal Information	42
Worldwide Sales and Design Support	42
Products	42
PSoC® Solutions	
Cypress Developer Community	
Technical Support	



Functional Definition

CPU and Memory Subsystem

CPU

The Cortex-M0 CPU in PSoC 4100 is part of the 32-bit MCU subsystem, which is optimized for low power operation with extensive clock gating. It mostly uses 16-bit instructions and executes a subset of the Thumb-2 instruction set. This enables fully compatible binary upward migration of the code to higher performance processors such as the Cortex-M3 and M4, thus enabling upward compatibility. The Cypress implementation includes a hardware multiplier that provides a 32-bit result in one cycle. It includes a nested vectored interrupt controller (NVIC) block with 32 interrupt inputs and also includes a Wakeup Interrupt Controller (WIC), which can wake the processor up from Deep Sleep mode allowing power to be switched off to the main processor when the chip is in Deep Sleep mode. The Cortex-M0 CPU provides a Non-Maskable Interrupt input (NMI), which is made available to the user when it is not in use for system functions requested by the user.

The CPU also includes a debug interface, the serial wire debug (SWD) interface, which is a two-wire form of JTAG; the debug configuration used for PSoC 4100 has four break-point (address) comparators and two watchpoint (data) comparators.

Flash

PSoC 4100 has a flash module with a flash accelerator tightly coupled to the CPU to improve average access times from the flash block. The flash block is designed to deliver 0 wait-state (WS) access time at 24 MHz. Part of the flash module can be used to emulate EEPROM operation if required.

The PSoC 4200 Flash supports the following flash protection modes at the memory subsystem level:

- Open: No Protection. Factory default mode in which the product is shipped.
- Protected: User may change from Open to Protected. This mode disables Debug interface accesses. The mode can be set back to Open but only after completely erasing the Flash.
- Kill: User may change from Open to Kill. This mode disables all Debug accesses. The part cannot be erased externally, thus obviating the possibility of partial erasure by power interruption and potential malfunction and security leaks. This is an irrecvocable mode.

In addition, row-level Read/Write protection is also supported to prevent inadvertent Writes as well as selectively block Reads. Flash Read/Write/Erase operations are always available for internal code using system calls.

SRAM

SRAM memory is retained during Hibernate.

SROM

A supervisory ROM that contains boot and configuration routines is provided.

System Resources

Power System

The power system is described in detail in the section Power on page 15. It provides assurance that voltage levels are as required for each respective mode and either delay mode entry (on power-on reset (POR), for example) until voltage levels are as required for proper function or generate resets (brown-out detect (BOD)) or interrupts (low-voltage detect (LVD)). The PSoC 4100 operates with a single external supply over the range of 1.71 V to 5.5 V and has five different power modes, transitions between which are managed by the power system. PSoC 4100 provides Sleep, Deep Sleep, Hibernate, and Stop low-power modes.

Clock System

The PSoC 4100 clock system is responsible for providing clocks to all subsystems that require clocks and for switching between different clock sources without glitching. In addition, the clock system ensures that no metastable conditions occur.

The clock system for PSoC 4100 consists of the internal main oscillator (IMO) and the internal low-power oscillator (ILO) and provision for an external clock.

Figure 3. PSoC 4100 MCU Clocking Architecture



The HFCLK signal can be divided down (see PSoC 4100 MCU Clocking Architecture) to generate synchronous clocks for the analog and digital peripherals. There are a total of 12 clock dividers for PSoC 4100, each with 16-bit divide capability. The analog clock leads the digital clocks to allow analog events to occur before digital clock-related noise is generated. The 16-bit capability allows a lot of flexibility in generating fine-grained frequency values and is fully supported in PSoC Creator.



IMO Clock Source

The IMO is the primary source of internal clocking in the PSoC 4100. It is trimmed during testing to achieve the specified accuracy. Trim values are stored in nonvolatile latches (NVL). Additional trim settings from flash can be used to compensate for changes. The IMO default frequency is 24 MHz and it can be adjusted between 3 MHz to 24 MHz in steps of 1 MHz. The IMO tolerance with Cypress-provided calibration settings is ±2%.

ILO Clock Source

The ILO is a very low power oscillator, which is primarily used to generate clocks for peripheral operation in Deep Sleep mode. ILO-driven counters can be calibrated to the IMO to improve accuracy. Cypress provides a software component, which does the calibration.

Watchdog Timer

A watchdog timer is implemented in the clock block running from the ILO; this allows watchdog operation during Deep Sleep and generates a watchdog reset if not serviced before the timeout occurs. The watchdog reset is recorded in the Reset Cause register.

Reset

PSoC 4100 can be reset from a variety of sources including a software reset. Reset events are asynchronous and guarantee reversion to a known state. The reset cause is recorded in a register, which is sticky through reset and allows software to determine the cause of the reset. An XRES pin is reserved for external reset to avoid complications with configuration and multiple pin functions during power-on or reconfiguration. The XRES pin has an internal pull-up resistor that is always enabled.

Voltage Reference

The PSoC 4100 reference system generates all internally required references. A 1% voltage reference spec is provided for the 12-bit ADC. To allow better signal to noise ratios (SNR) and better absolute accuracy, it is possible to bypass the internal reference using a GPIO pin or to use an external reference for the SAR.

Analog Blocks

12-bit SAR ADC

The 12-bit 806 ksps SAR ADC can operate at a maximum clock rate of 14.5 MHz and requires a minimum of 18 clocks at that frequency to do a 12-bit conversion.

The block functionality is augmented for the user by adding a reference buffer to it (trimmable to \pm 1%) and by providing the choice (for the PSoC 4100 case) of three internal voltage references: V_{DD}, V_{DD}/2, and V_{REF} (nominally 1.024 V) as well as an external reference through a GPIO pin. The sample-and-hold (S/H) aperture is programmable allowing the gain bandwidth requirements of the amplifier driving the SAR inputs, which determine its settling time, to be relaxed if required. System performance will be 65 dB for true 12-bit precision providing appropriate references are used and system noise levels permit. To improve performance in noisy conditions, it is possible to provide an external bypass (through a fixed pin location) for the internal reference amplifier.

The SAR is connected to a fixed set of pins through an 8-input sequencer. The sequencer cycles through selected channels autonomously (sequencer scan) and does so with zero switching overhead (that is, aggregate sampling bandwidth is equal to 806 ksps whether it is for a single channel or distributed over several channels). The sequencer switching is effected through a state machine or through firmware driven switching. A feature provided by the sequencer is buffering of each channel to reduce CPU interrupt service requirements. To accommodate signals with varying source impedance and frequency, it is possible to have different sample times programmable for each channel. Also, signal range specification through a pair of range registers (low and high range values) is implemented with a corresponding out-of-range interrupt if the digitized value exceeds the programmed range; this allows fast detection of out-of-range values without the necessity of having to wait for a sequencer scan to be completed and the CPU to read the values and check for out-of-range values in software.

The SAR is able to digitize the output of the on-board temperature sensor for calibration and other temperature-dependent functions. The SAR is not available in Deep Sleep and Hibernate modes as it requires a high-speed clock (up to 18 MHz). The SAR operating range is 1.71 V to 5.5 V.



Figure 4. SAR ADC System Diagram



GPIO

PSoC 4100 has 36 GPIOs. The GPIO block implements the following:

- Eight drive strength modes:
 - Analog input mode (input and output buffers disabled)
 Input only
 - Weak pull-up with strong pull-down
 - □ Strong pull-up with weak pull-down
 - Open drain with strong pull-down
 - Open drain with strong pull-up
 - □ Strong pull-up with strong pull-down
 - Weak pull-up with weak pull-down
- Input threshold select (CMOS or LVTTL).
- Individual control of input and output buffer enabling/disabling in addition to the drive strength modes.
- Hold mode for latching previous state (used for retaining I/O state in Deep Sleep mode and Hibernate modes).
- Selectable slew rates for dV/dt related noise control to improve EMI.

The pins are organized in logical entities called ports, which are 8-bit in width. During power-on and reset, the blocks are forced to the disable state so as not to crowbar any inputs and/or cause excess turn-on current. A multiplexing network known as a high-speed I/O matrix is used to multiplex between various signals that may connect to an I/O pin. Pin locations for fixed-function peripherals are also fixed to reduce internal multiplexing complexity.

Data output and pin state registers store, respectively, the values to be driven on the pins and the states of the pins themselves. Every I/O pin can generate an interrupt if so enabled and each I/O port has an interrupt request (IRQ) and interrupt service routine (ISR) vector associated with it (5 for PSoC 4100 since it has 4.5 ports).

Special Function Peripherals

LCD Segment Drive

PSoC 4100 has an LCD controller which can drive up to four commons and up to 32 segments. It uses full digital methods to drive the LCD segments requiring no generation of internal LCD voltages. The two methods used are referred to as digital correlation and PWM.

Digital correlation pertains to modulating the frequency and levels of the common and segment signals to generate the highest RMS voltage across a segment to light it up or to keep the RMS signal zero. This method is good for STN displays but may result in reduced contrast with TN (cheaper) displays.

PWM pertains to driving the panel with PWM signals to effectively use the capacitance of the panel to provide the integration of the modulated pulse-width to generate the desired LCD voltage. This method results in higher power consumption but can result in better results when driving TN displays. LCD operation is supported during Deep Sleep refreshing a small display buffer (4 bits; 1 32-bit register per port).

CapSense

CapSense is supported on all pins in the PSoC 4100 through a CapSense Sigma-Delta (CSD) block that can be connected to any pin through an analog mux bus that any GPIO pin can be connected to via an Analog switch. CapSense function can thus be provided on any pin or group of pins in a system under software control. A component is provided for the CapSense block to make it easy for the user.

Shield voltage can be driven on another mux bus to provide water tolerance capability. Water tolerance is provided by driving the shield electrode in phase with the sense electrode to keep the shield capacitance from attenuating the sensed input.

The CapSense block has two IDACs which can be used for general purposes if CapSense is not being used.(both IDACs are available in that case) or if CapSense is used without water tolerance (one IDAC is available).

WLCSP Package Bootloader

The WLCSP package is supplied with an I²C Bootloader installed in flash. The bootloader is compatible with PSoC Creator bootloadable project files and has the following default settings:

- I²C SCL and SDA connected to port pins P4.0 and P4.1 respectively (external pull-up resistors required)
- I²C Slave mode, address 8, data rate = 100 kbps
- Single application
- Wait two seconds for bootload command
- Other bootloader options are as set by the PSoC Creator Bootloader Component default
- Occupies the bottom 4.5 K of flash

For more information on this bootloader, see the following Cypress application notes:

AN73854 - Introduction to Bootloaders

Note that a PSoC Creator bootloadable project must be associated with *.hex* and *.elf* files for a bootloader project that is configured for the target device. Bootloader *.hex* and *.elf* files can be found at http://www.cypress.com/?rID=78805. The factory-installed bootloader can be overwritten using JTAG or SWD programming.



Pinouts

The following is the pin-list for PSoC 4100 (44-TQFP, 40-QFN, 28-SSOP, and 48-TQFP). Port 2 comprises of the high-speed Analog inputs for the SAR Mux. P1.7 is the optional external input and bypass for the SAR reference. Ports 3 and 4 contain the Digital Communication channels. All pins support CSD CapSense and analog mux bus connections.

4	4-TQFP	40	D-QFN	2	8-SSOP	48	B-TQFP		Alte	ernate Functions f	or Pins		Die Deserietien
Pin	Name	Pin	Name	Pin	Name	Pin	Name	Analog	Alt 1	Alt 2	Alt 3	Alt 4	Pin Description
1	VSS	-	-	-	-	-	-	-	-	-	-	-	Ground
2	P2.0	1	P2.0	-	-	2	P2.0	sarmux.0	-	-	-	-	Port 2 Pin 0: gpio, lcd, csd, sarmux
3	P2.1	2	P2.1	-	-	3	P2.1	sarmux.1	-	-	-	-	Port 2 Pin 1: gpio, lcd, csd, sarmux
4	P2.2	3	P2.2	5	P2.2	4	P2.2	sarmux.2	-	-	-	-	Port 2 Pin 2: gpio, lcd, csd, sarmux
5	P2.3	4	P2.3	6	P2.3	5	P2.3	sarmux.3	-	-	-	-	Port 2 Pin 3: gpio, lcd, csd, sarmux
6	P2.4	5	P2.4	7	P2.4	6	P2.4	sarmux.4	tcpwm0_p[1]	-	-	-	Port 2 Pin 4: gpio, lcd, csd, sarmux, pwm
7	P2.5	6	P2.5	8	P2.5	7	P2.5	sarmux.5	tcpwm0_n[1]	-	-	-	Port 2 Pin 5: gpio, lcd, csd, sarmux, pwm
8	P2.6	7	P2.6	9	P2.6	8	P2.6	sarmux.6	tcpwm1_p[1]	-	-	-	Port 2 Pin 6: gpio, lcd, csd, sarmux, pwm
9	P2.7	8	P2.7	10	P2.7	9	P2.7	sarmux.7	tcpwm1_n[1]	_	_	_	Port 2 Pin 7: gpio, lcd, csd, sarmux, pwm
10	VSS	9	VSS	-	-	-	-	-	-	-	-	-	Ground
-	-	-	-	-	-	10	NC	-	-	-	-	-	No Connect
-	-	-	-	-	-	11	NC	-	-	-	-	-	No Connect
11	P3.0	10	P3.0	11	P3.0	12	P3.0	-	tcpwm0_p[0]	scb1_uart_rx[0]	scb1_i2c_scl[0]	scb1_spi_mosi[0]	Port 3 Pin 0: gpio, lcd, csd, pwm, scb1
12	P3.1	11	P3.1	12	P3.1	13	P3.1	-	tcpwm0_n[0]	scb1_uart_tx[0]	scb1_i2c_sda[0]	scb1_spi_miso[0]	Port 3 Pin 1: gpio, lcd, csd, pwm, scb1
13	P3.2	12	P3.2	13	P3.2	14	P3.2	-	tcpwm1_p[0]	-	swd_io[0]	scb1_spi_clk[0]	Port 3 Pin 2: gpio, lcd, csd, pwm, scb1, swd
-	-	-	-	-	-	15	VSSD	-	-	-	-	-	Ground
14	P3.3	13	P3.3	14	P3.3	16	P3.3	-	tcpwm1_n[0]	-	swd_clk[0]	scb1_spi_ssel_0[0]	Port 3 Pin 3: gpio, lcd, csd, pwm, scb1, swd
15	P3.4	14	P3.4	-	-	17	P3.4	-	tcpwm2_p[0]	-	-	scb1_spi_ssel_1	Port 3 Pin 4: gpio, lcd, csd, pwm, scb1
16	P3.5	15	P3.5	-	-	18	P3.5	-	tcpwm2_n[0]	-	-	scb1_spi_ssel_2	Port 3 Pin 5: gpio, lcd, csd, pwm, scb1
17	P3.6	16	P3.6	-	-	19	P3.6	-	tcpwm3_p[0]	-	swd_io[1]	scb1_spi_ssel_3	Port 3 Pin 6: gpio, lcd, csd, pwm, scb1, swd
18	P3.7	17	P3.7	-	-	20	P3.7	-	tcpwm3_n[0]	-	swd_clk[1]	-	Port 3 Pin 7: gpio, lcd, csd, pwm, swd
19	VDDD	-	-	-	-	21	VDDD	-	-	-	-	-	Digital Supply, 1.8 - 5.5V
20	P4.0	18	P4.0	15	P4.0	22	P4.0	-	-	scb0_uart_rx	scb0_i2c_scl	scb0_spi_mosi	Port 4 Pin 0: gpio, lcd, csd, scb0
21	P4.1	19	P4.1	16	P4.1	23	P4.1	-	-	scb0_uart_tx	scb0_i2c_sda	scb0_spi_miso	Port 4 Pin 1: gpio, lcd, csd, scb0
22	P4.2	20	P4.2	17	P4.2	24	P4.2	csd_c_mod	-	-	-	scb0_spi_clk	Port 4 Pin 2: gpio, lcd, csd, scb0
23	P4.3	21	P4.3	18	P4.3	25	P4.3	csd_c_sh_tank		-	-	scb0_spi_ssel_0	Port 4 Pin 3: gpio, lcd, csd, scb0
-	-	-	-	-	-	26	NC	-		_	_	-	No Connect
-	-	-	-	-	-	27	NC	-	-	-	-	-	No Connect

PSoC[®] 4: PSoC 4100 Family Datasheet



4	44-TQFP		40-QFN		28-SSOP		8-TQFP	Alternate Functions for Pins					Pin Description
Pin	Name	Pin	Name	Pin	Name	Pin	Name	Analog	Alt 1	Alt 2	Alt 3	Alt 4	Pin Description
24	P0.0	22	P0.0	19	P0.0	28	P0.0	comp1_inp	-	-	-	scb0_spi_ssel_1	Port 0 Pin 0: gpio, lcd, csd, scb0, comp
25	P0.1	23	P0.1	20	P0.1	29	P0.1	comp1_inn	-	-	-	scb0_spi_ssel_2	Port 0 Pin 1: gpio, lcd, csd, scb0, comp
26	P0.2	24	P0.2	21	P0.2	30	P0.2	comp2_inp	-	-	-	scb0_spi_ssel_3	Port 0 Pin 2: gpio, lcd, csd, scb0, comp
27	P0.3	25	P0.3	22	P0.3	31	P0.3	comp2_inn	-	-	-	-	Port 0 Pin 3: gpio, lcd, csd, comp
28	P0.4	26	P0.4	-	-	32	P0.4	-	-	scb1_uart_rx[1]	scb1_i2c_scl[1]	scb1_spi_mosi[1]	Port 0 Pin 4: gpio, lcd, csd, scb1
29	P0.5	27	P0.5	-	-	33	P0.5	-	-	scb1_uart_tx[1]	scb1_i2c_sda[1]	scb1_spi_miso[1]	Port 0 Pin 5: gpio, lcd, csd, scb1
30	P0.6	28	P0.6	23	P0.6	34	P0.6	-	ext_clk	-	-	scb1_spi_clk[1]	Port 0 Pin 6: gpio, lcd, csd, scb1, ext_clk
31	P0.7	29	P0.7	24	P0.7	35	P0.7	-	-	-	wakeup	scb1_spi_ssel_0[1]	Port 0 Pin 7: gpio, lcd, csd, scb1, wakeup
32	XRES	30	XRES	25	XRES	36	XRES	-	-	-	-	-	Chip reset, active low
33	VCCD	31	VCCD	26	VCCD	37	VCCD	-	-	-	-	-	Regulated supply, connect to 1µF cap or 1.8V
-	-	-	-	-	-	38	VSSD	-	-	-	-	-	Digital Ground
34	VDDD	32	VDDD	27	VDD	39	VDDD	-	-	-	-	-	Digital Supply, 1.8 - 5.5V
35	VDDA	33	VDDA	27	VDD	40	VDDA	-	-	-	-	-	Analog Supply, 1.8 - 5.5V, equal to VDDD
36	VSSA	34	VSSA	28	VSS	41	VSSA	-	-	-	-	-	Analog Ground
37	P1.0	35	P1.0	1	P1.0	42	P1.0	ctb.oa0.inp	tcpwm2_p[1]	-	-	-	Port 1 Pin 0: gpio, lcd, csd, ctb, pwm
38	P1.1	36	P1.1	2	P1.1	43	P1.1	ctb.oa0.inm	tcpwm2_n[1]	-	_	_	Port 1 Pin 1: gpio, lcd, csd, ctb, pwm
39	P1.2	37	P1.2	3	P1.2	44	P1.2	ctb.oa0.out	tcpwm3_p[1]	-	_	_	Port 1 Pin 2: gpio, lcd, csd, ctb, pwm
40	P1.3	38	P1.3	-	-	45	P1.3	ctb.oa1.out	tcpwm3_n[1]	-	-	-	Port 1 Pin 3: gpio, lcd, csd, ctb, pwm
41	P1.4	39	P1.4	-	-	46	P1.4	ctb.oa1.inm	-	-	-	-	Port 1 Pin 4: gpio, lcd, csd, ctb
42	P1.5	-	-	-	-	47	P1.5	ctb.oa1.inp	Ι	_	_	_	Port 1 Pin 5: gpio, lcd, csd, ctb
43	P1.6	-	-	-	-	48	P1.6	ctb.oa0.inp_alt	_	_	_	_	Port 1 Pin 6: gpio, lcd, csd
44	P1.7/VREF	40	P1.7/VREF	4	P1.7/VREF	1	P1.7/VREF	ctb.oa1.inp_alt ext_vref	-	-	-	-	Port 1 Pin 7: gpio, lcd, csd, ext_ref

Notes:

1. tcpwm_p and tcpwm_n refer to tcpwm non-inverted and inverted outputs respectively.

2. P3.2 and P3.3 are SWD pins after boot (reset).



Figure 7. 40-Pin QFN Pinout



Figure 8. 35-Ball WLCSP



Figure 9. 28-Pin SSOP Pinout

(GPIQ) P1[0] (GPIQ) P1[7] (GPIQ) P1[7] (GPIQ) P1[7] (GPIQ) P2[2] (GPIQ) P2[3] (GPIQ) P2[3] (GPIQ) P2[5] (GPIQ) P2[5] (GPIQ) P2[6]	1 2 3 4 5 6 7 8 9 9 10	SSOP (Top View)	28 VSS 27 VDDD 26 VCCD 25 XRES 24 (GPI0) P0[7] 23 (GPI0) P0[3] 21 (GPI0) P0[3] 21 (GPI0) P0[2] 20 (GPI0) P0[2] 20 (GPI0) P0[2] 21 (GPI0) P0[2] 20 (G
(GPIO) P1[7]	4		25 KRES
(GPIO) P2[2]	5	SSUB	24 d (GPIO) P0[7]
(GPIO) P2[3]	a 6		23 GPIO) P0[6]
(GPIO) P2[4]	7	(Top View)	22 GPIO) P0[3]
(GPIO) P2[5]	a 8		21 a (GPIO) P0[2]
(GPIO) P2[6]	9		20 GPIO) P0[1]
(GPIO)P2[7]	= 10		19 d (GPIO) P0[0]
(GPIO) P3[0]	= 11		18 d (GPIO) P4[3]
(GPIO)P3[1]	= 12		17 GPIO)P4[2]
(GPIO)P3[2]	= 13		16 GPIO)P4[1]
(GPIO)P3[3]	= 14		15 GPIO) P4[0]



Power

The following power system diagrams show the minimum set of power supply pins as implemented for PSoC 4100. The system has one regulator in Active mode for the digital circuitry. There is no analog regulator; the analog circuits run directly from the V_{DDA} input. There are separate regulators for the Deep Sleep and Hibernate (lowered power supply and retention) modes. There is a separate low-noise regulator for the bandgap. The supply voltage range is 1.71 V to 5.5 V with all functions and circuits operating over that range.





The PSoC 4100 family allows two distinct modes of power supply operation: Unregulated External Supply, and Regulated External Supply modes.

Unregulated External Supply

In this mode, PSoC 4100 is powered by an external power supply that can be anywhere in the range of 1.8 V to 5.5 V. This range is also designed for battery-powered operation, for instance, the chip can be powered from a battery system that starts at 3.5 V and works down to 1.8 V. In this mode, the internal regulator of PSoC 4100 supplies the internal logic and the V_{CCD} output of the PSoC 4100 must be bypassed to ground via an external Capacitor (in the range of 1 μ F to 1.6 μ F; X5R ceramic or better).

 V_{DDA} and V_{DDD} must be shorted together; the grounds, VSSA and V_{SS} must also be shorted together. Bypass capacitors must be used from V_{DDD} to ground, typical practice for systems in this frequency range is to use a capacitor in the 1- μF range in parallel with a smaller capacitor (0.1 μF for example). Note that these are simply rules of thumb and that, for critical applications, the PCB layout, lead inductance, and the Bypass capacitor parasitic should be simulated to design and obtain optimal bypassing.

Figure 11. 48-TQFP Package Example



Figure 12. 44-TQFP Package Example



Power Supply	Bypass Capacitors
VDDD-VSS	0.1 μ F ceramic at each pin (C2, C6) plus bulk capacitor 1 to 10 μ F (C1). Total capac- itance may be greater than 10 μ F.
VDDA-VSSA	0.1 μ F ceramic at pin (C4). Additional 1 μ F to 10 μ F (C3) bulk capacitor. Total capacitance may be greater than 10 μ F.
VCCD-VSS	1 μF ceramic capacitor at the VCCD pin (C5)
VREF–VSSA (optional)	The internal bandgap may be bypassed with a 1 μ F to 10 μ F capacitor. Total capacitance may be greater than 10 μ F.



Note It is good practice to check the datasheets for your bypass capacitors, specifically the working voltage and the DC bias specifications. With some capacitors, the actual capacitance can decrease considerably when the DC bias (V_{DDA} , V_{DDD} , or V_{CCD}) is a significant percentage of the rated working voltage. V_{DDA} must be equal to or higher than the V_{DDD} supply when powering up.



Figure 13. 40-pin QFN Example





Regulated External Supply

In this mode, the PSoC 4100 is powered by an external power supply that must be within the range of 1.71 V to 1.89 V (1.8 \pm 5%); note that this range needs to include power supply ripple too. In this mode, VCCD, VDDA, and VDDD pins are all shorted together and bypassed. The internal regulator is disabled in firmware.



Analog Peripherals

Opamp

Table 8. Opamp Specifications (Guaranteed by Characterization)

Spec ID#	Parameter	Description	Min	Тур	Мах	Units	Details/ Conditions
	I _{DD}	Opamp block current. No load.	-	-	-	-	
SID269	I _{DD_HI}	Power = high	-	1100	1850	μA	
SID270	I _{DD_MED}	Power = medium	-	550	950	μA	
SID271	IDD LOW	Power = low	-	150	350	μA	
	GBW	Load = 20 pF, 0.1 mA. V _{DDA} = 2.7 V	-	-	-	-	
SID272	GBW_HI	Power = high	6	-	_	MHz	
SID273	GBW_MED	Power = medium	4	-	-	MHz	
SID274	GBW_LO	Power = low	_	1	-	MHz	
	IOUT MAX	$V_{DDA} \ge 2.7 \text{ V}, 500 \text{ mV}$ from rail	-	-	-	-	
SID275	IOUT MAX HI	Power = high	10	-	_	mA	
SID276	IOUT MAX MID	Power = medium	10	-	_	mA	
SID277	OUT MAX LO	Power = low	_	5	_	mA	
		V _{DDA} = 1.71 V, 500 mV from rail	_	-	_	_	
SID278	IOUT MAX HI	Power = high	4	_	_	mA	
SID279		Power = medium	4	-	_	mA	
SID280		Power = low	_	2	_	mA	
SID281	V _{IN}	Charge pump on, $V_{DDA} \ge 2.7 V$	-0.05	-	V _{DDA} – 0.2	V	
SID282	V _{CM}	Charge pump on, $V_{DDA} \ge 2.7 \text{ V}$	-0.05	-	$V_{DDA} - 0.2$	V	
	V _{OUT}	$V_{DDA} \ge 2.7 V$	_	_	-		
SID283	V _{OUT 1}	Power = high, lload=10 mA	0.5	-	V _{DDA} – 0.5	V	
SID284	V _{OUT 2}	Power = high, lload=1 mA	0.2	-	$V_{DDA} - 0.2$	V	
SID285	V _{OUT 3}	Power = medium, Iload=1 mA	0.2	-	$V_{DDA} - 0.2$	V	
SID286	V _{OUT 4}	Power = low, lload=0.1 mA	0.2	-	$V_{DDA} - 0.2$	V	
SID288	V _{OS TR}	Offset voltage, trimmed	1	±0.5	1	mV	High mode
SID288A	V _{OS TR}	Offset voltage, trimmed	_	±1	_	mV	Medium mode
SID288B	V _{OS TR}	Offset voltage, trimmed	_	±2	_	mV	Low mode
SID290	V _{OS_DR_TR}	Offset voltage drift, trimmed	-10	±3	10	µV/°C	High mode. $T_A \le 85 \ ^{\circ}C$
SID290Q	VOS_DR_TR	Offset voltage drift, trimmed	15	±3	15	µV/°C	High mode. T _A ≤ 105 °C
SID290A	V _{OS DR TR}	Offset voltage drift, trimmed	_	±10	_	µV/°C	Medium mode
SID290B	V _{OS DR TR}	Offset voltage drift, trimmed	_	±10	_	µV/°C	Low mode
SID291	CMRR	DC	70	80	_	dB	V _{DDD} = 3.6 V
SID292	PSRR	At 1 kHz, 100-mV ripple	70	85	_	dB	V _{DDD} = 3.6 V
	Noise		_	_	_	_	
SID293	V _{N1}	Input referred, 1 Hz - 1GHz, power = high	-	94	_	µVrms	
SID294	V _{N2}	Input referred, 1 kHz, power = high	-	72	_	nV/rtHz	
SID295	V _{N3}	Input referred, 10kHz, power = high	-	28	_	nV/rtHz	
SID296	V _{N4}	Input referred, 100kHz, power = high	-	15	-	nV/rtHz	



Table 10. Comparator AC Specifications

(Guaranteed by Characterization)

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID91	T _{RESP1}	Response time, normal mode	-	-	110	ns	50-mV overdrive
SID258	T _{RESP2}	Response time, low power mode	-	-	200	ns	50-mV overdrive
SID92	T _{RESP3}	Response time, ultra low power mode ($V_{DDD} \ge 2.2 \text{ V}$ for Temp < 0 °C, $V_{DDD} \ge$ 1.8 V for Temp > 0 °C)	-	_	15	μs	200-mV overdrive

Temperature Sensor

Table 11. Temperature Sensor Specifications

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID93	T _{SENSACC}	Temperature sensor accuracy	-5	±1	+5	°C	–40 to +85 °C

SAR ADC

Table 12. SAR ADC DC Specifications

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID94	A_RES	Resolution	_	-	12	bits	
SID95	A_CHNIS_S	Number of channels - single ended	-	-	8		8 full speed
SID96	A-CHNKS_D	Number of channels - differential	_	-	4		Diff inputs use neighboring I/O
SID97	A-MONO	Monotonicity	_	-	-		Yes. Based on characterization
SID98	A_GAINERR	Gain error	_	_	±0.1	%	With external reference. Guaranteed by characterization
SID99	A_OFFSET	Input offset voltage	_	-	2	mV	Measured with 1-V V _{REF.} Guaranteed by characterization
SID100	A_ISAR	Current consumption	-	-	1	mA	
SID101	A_VINS	Input voltage range - single ended	V_{SS}	-	V _{DDA}	V	Based on device characterization
SID102	A_VIND	Input voltage range - differential	V_{SS}	-	V _{DDA}	V	Based on device characterization
SID103	A_INRES	Input resistance	_	-	2.2	KΩ	Based on device characterization
SID104	A_INCAP	Input capacitance	_	-	10	pF	Based on device characterization
SID106	A_PSRR	Power supply rejection ratio	70	-	-	dB	
SID107	A_CMRR	Common mode rejection ratio	66	-	Ι	dB	Measured at 1 V
SID111	A_INL	Integral non linearity	-1.7	_	+2	LSB	V _{DD} = 1.71 to 5.5, 806 ksps, V _{REF} = 1 to 5.5.
SID111A	A_INL	Integral non linearity	-1.5	_	+1.7	LSB	V _{DDD} = 1.71 to 3.6, 806 ksps, V _{REF} = 1.71 to V _{DDD} .



Digital Peripherals

The following specifications apply to the Timer/Counter/PWM peripheral in timer mode.

Timer/Counter/PWM

Table 15. TCPWM Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID.TCPWM.1	ITCPWM1	Block current consumption at 3 MHz	-	-	45	μA	All modes (TCPWM)
SID.TCPWM.2	ITCPWM2	Block current consumption at 12 MHz	-	-	155	μA	All modes (TCPWM)
SID.TCPWM.2A	ITCPWM3	Block current consumption at 48 MHz	-	-	650	μA	All modes (TCPWM)
SID.TCPWM.3	TCPWMFREQ	Operating frequency	-	-	Fc	MHz	Fc max = Fcpu. Maximum = 24 MHz
SID.TCPWM.4	TPWMENEXT	Input Trigger Pulse Width for all Trigger Events	2/Fc	-	-	ns	Trigger events can be Stop, Start, Reload, Count, Capture, or Kill depending on which mode of operation is selected.
SID.TCPWM.5	TPWMEXT	Output Trigger Pulse widths	2/Fc	-	_	ns	Minimum possible width of Overflow, Underflow, and CC (Counter equals Compare value) trigger outputs
SID.TCPWM.5A	TCRES	Resolution of Counter	1/Fc	-	-	ns	Minimum time between successive counts
SID.TCPWM.5B	PWMRES	PWM Resolution	1/Fc	_	_	ns	Minimum pulse width of PWM Output
SID.TCPWM.5C	QRES	Quadrature inputs resolution	1/Fc	_	_	ns	Minimum pulse width between Quadrature phase inputs.

βC

Table 16. Fixed I²C DC Specifications (Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID149	I _{I2C1}	Block current consumption at 100 kHz	-	-	50	μA	
SID150	I _{I2C2}	Block current consumption at 400 kHz	-	-	135	μA	
SID151	I _{I2C3}	Block current consumption at 1 Mbps	-	-	310	μA	
SID152	I _{I2C4}	I ² C enabled in Deep Sleep mode	_	-	1.4	μA	

Table 17. Fixed I²C AC Specifications (Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Тур	Мах	Units	Details/Conditions
SID153	F _{I2C1}	Bit rate	-	-	1	Mbps	

LCD Direct Drive

Table 18. LCD Direct Drive DC Specifications (Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID154	ILCDLOW	Operating current in low power mode	-	5	-	μA	16 × 4 small segment disp. at 50 Hz
SID155	C _{LCDCAP}	LCD capacitance per segment/common driver	-	500	5000	pF	Guaranteed by Design
SID156	LCD _{OFFSET}	Long-term segment offset	-	20	-	mV	
SID157	I _{LCDOP1}	DOP1 PWM Mode current. 5-V bias. 24-MHz IMO. 25 °C		0.6	-	mA	32 × 4 segments. 50 Hz
SID158	I _{LCDOP2}	PWM Mode current. 3.3-V bias. 24-MHz IMO. 25 °C	_	0.5	_	mA	32 × 4 segments. 50 Hz



Internal Main Oscillator

Table 33. IMO DC Specifications (Guaranteed by Design)

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID218	I _{IMO1}	IMO operating current at 48 MHz	-	-	1000	μA	
SID219	I _{IMO2}	IMO operating current at 24 MHz	-	-	325	μA	
SID220	I _{IMO3}	IMO operating current at 12 MHz	-	-	225	μA	
SID221	I _{IMO4}	IMO operating current at 6 MHz	-	-	180	μA	
SID222	I _{IMO5}	IMO operating current at 3 MHz	-	-	150	μA	

Table 34. IMO AC Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID223	F _{IMOTOL1}	Frequency variation from 3 to 48 MHz	_	-	±2	%	±3% if T _A > 85 °C and IMO frequency < 24 MHz
SID226	T _{STARTIMO}	IMO startup time	-	-	12	μs	
SID227	T _{JITRMSIMO1}	RMS Jitter at 3 MHz	-	156	-	ps	
SID228	T _{JITRMSIMO2}	RMS Jitter at 24 MHz	-	145	-	ps	
SID229	T _{JITRMSIMO3}	RMS Jitter at 48 MHz	-	139	-	ps	

Internal Low-Speed Oscillator

Table 35. ILO DC Specifications (Guaranteed by Design)

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID231	I _{ILO1}	ILO operating current at 32 kHz	_	0.3	1.05	μA	Guaranteed by Characterization
SID233	IILOLEAK	ILO leakage current	_	2	15	nA	Guaranteed by Design

Table 36. ILO AC Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID234	T _{STARTILO1}	ILO startup time	-	-	2	ms	Guaranteed by charac- terization
SID236	T _{ILODUTY}	ILO duty cycle	40	50	60	%	Guaranteed by charac- terization
SID237	F _{ILOTRIM1}	32 kHz trimmed frequency	15	32	50	kHz	Max ILO frequency is 70 kHz if T _A > 85 °C

Table 37. External Clock Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID305	ExtClkFreq	External Clock input Frequency	0	-	24	MHz	Guaranteed by characterization
SID306	ExtClkDuty	Duty cycle; Measured at V _{DD/2}	45	-	55	%	Guaranteed by characterization



Part Numbering Conventions

PSoC 4 devices follow the part numbering convention described in the following table. All fields are single-character alphanumeric (0, 1, 2, ..., 9, A,B, ..., Z) unless stated otherwise.

The part numbers are of the form CY8C4ABCDEF-XYZ where the fields are defined as follows.

Example	$\underline{CY8C} 4 \underline{A} \underline{B} \underline{C} \underline{D} \underline{E} \underline{F} - \underline{X} \underline{Y} \underline{Z}$
	Cypress Prefix
4: PSoC 4	Architecture
1: 4100Family	Family within Architecture
2: 24 MHz	Speed Grade
5: 32KB	Flash Capacity
AX: TQFP	Package Code
I: Industrial	Temperature Range
	Attributes Set

The Field Values are listed in the following table.

Field	Description	Values	Meaning
CY8C	Cypress Prefix		
4	Architecture	4	PSoC 4
۸	Family within architecture	1	4100 Family
		2	4200 Family
в	P CDU Speed		24 MHz
В	Ci O Speed	4	48 MHz
C	Flash Capacity	4	16 KB
C	Thash Capacity	5	32 KB
		AX, AZ	TQFP
DE	Package Code	LQ	QFN
	1 ackage code	PV	SSOP
		FN	WLCSP
F	Temperature Pange	I	Industrial
		Q	Extended Industrial
XYZ	Attributes Code	000-999	Code of feature set in specific family



Packaging

Table 40. Package Characteristics

Parameter	Description	Conditions	Min	Тур	Мах	Units
T _A	Operating ambient temperature		-40	25.00	105	°C
TJ	Operating junction temperature		-40	-	125	°C
T _{JA}	Package θ_{JA} (28-pin SSOP)		-	66.58	-	°C/Watt
T _{JA}	Package θ_{JA} (35-ball WLCSP)		-	28.00	-	°C/Watt
T _{JA}	Package θ_{JA} (40-pin QFN)		-	15.34	-	°C/Watt
T _{JA}	Package θ_{JA} (44-pin TQFP)		-	57.16	-	°C/Watt
T _{JA}	Package θ_{JA} (48-pin TQFP)		-	67.30	-	°C/Watt
T _{JC}	Package θ_{JC} (28-pin SSOP)		-	26.28	-	°C/Watt
T _{JC}	Package θ_{JC} (35-ball WLCSP)		-	00.40	-	°C/Watt
T _{JC}	Package θ_{JC} (40-pin QFN)		-	2.50	-	°C/Watt
T _{JC}	Package θ_{JC} (44-pin TQFP)		-	17.47	-	°C/Watt
T _{JC}	Package θ_{JC} (48-pin TQFP)		-	27.60	-	°C/Watt

Table 41. Solder Reflow Peak Temperature

Package	Maximum Peak Temperature	Maximum Time at Peak Temperature
28-pin SSOP	260 °C	30 seconds
35-ball WLCSP	260 °C	30 seconds
40-pin QFN	260 °C	30 seconds
44-pin TQFP	260 °C	30 seconds
48-pin TQFP	260 °C	30 seconds

Table 42. Package Moisture Sensitivity Level (MSL), IPC/JEDEC J-STD-2

Package	MSL
28-pin SSOP	MSL 3
35-ball WLCSP	MSL 3
40-pin QFN	MSL 3
44-pin TQFP	MSL 3
48-pin TQFP	MSL 3

PSoC 4 CAB Libraries with Schematics Symbols and PCB Footprints are on the Cypress web site at http://www.cypress.com/cad-resources/psoc-4-cad-libraries?source=search&cat=technical_documents.





Figure 16. 35-ball WLCSP Package Outline





BOTTOM VIEW







NOTES:

- 1. REFERENCE JEDEC PUBLICATION 95, DESIGN GUIDE 4.18
- 2. ALL DIMENSIONS ARE IN MILLIMETERS

001-93741 **



Acronym	Description
PC	program counter
PCB	printed circuit board
PGA	programmable gain amplifier
PHUB	peripheral hub
PHY	physical layer
PICU	port interrupt control unit
PLA	programmable logic array
PLD	programmable logic device, see also PAL
PLL	phase-locked loop
PMDD	package material declaration data sheet
POR	power-on reset
PRES	precise power-on reset
PRS	pseudo random sequence
PS	port read data register
PSoC [®]	Programmable System-on-Chip™
PSRR	power supply rejection ratio
PWM	pulse-width modulator
RAM	random-access memory
RISC	reduced-instruction-set computing
RMS	root-mean-square
RTC	real-time clock
RTL	register transfer language
RTR	remote transmission request
RX	receive
SAR	successive approximation register
SC/CT	switched capacitor/continuous time
SCL	I ² C serial clock
SDA	I ² C serial data
S/H	sample and hold
SINAD	signal to noise and distortion ratio
SIO	special input/output, GPIO with advanced features. See GPIO.
SOC	start of conversion
SOF	start of frame
SPI	Serial Peripheral Interface, a communications protocol
SR	slew rate
SRAM	static random access memory
SRES	software reset
SWD	serial wire debug, a test protocol

Table 43. Acronyms Used in this Document (continued)

Acronym Description SWV single-wire viewer TD transaction descriptor, see also DMA THD total harmonic distortion TIA transimpedance amplifier TRM technical reference manual TTL transistor-transistor logic ΤХ transmit UART Universal Asynchronous Transmitter Receiver, a communications protocol UDB universal digital block USB Universal Serial Bus USBIO USB input/output, PSoC pins used to connect to a USB port VDAC voltage DAC, see also DAC, IDAC WDT watchdog timer WOL write once latch, see also NVL WRES watchdog timer reset **XRES** external reset I/O pin XTAL crystal

Table 43. Acronyms Used in this Document (continued)



Document Conventions

Units of Measure

Table 44. Units of Measure

Symbol	Unit of Measure
°C	degrees Celsius
dB	decibel
fF	femto farad
Hz	hertz
KB	1024 bytes
kbps	kilobits per second
Khr	kilohour
kHz	kilohertz
kΩ	kilo ohm
ksps	kilosamples per second
LSB	least significant bit
Mbps	megabits per second
MHz	megahertz
MΩ	mega-ohm
Msps	megasamples per second
μA	microampere
μF	microfarad
μH	microhenry
μs	microsecond
μV	microvolt
μW	microwatt
mA	milliampere
ms	millisecond
mV	millivolt
nA	nanoampere
ns	nanosecond
nV	nanovolt
Ω	ohm
pF	picofarad
ppm	parts per million
ps	picosecond
s	second
sps	samples per second
sqrtHz	square root of hertz
V	volt



Sales, Solutions, and Legal Information

Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at Cypress Locations.

Products

ARM [®] Cortex [®] Microcontrollers	cypress.com/arm
Automotive	cypress.com/automotive
Clocks & Buffers	cypress.com/clocks
Interface	cypress.com/interface
Internet of Things	cypress.com/iot
Memory	cypress.com/memory
Microcontrollers	cypress.com/mcu
PSoC	cypress.com/psoc
Power Management ICs	cypress.com/pmic
Touch Sensing	cypress.com/touch
USB Controllers	cypress.com/usb
Wireless Connectivity	cypress.com/wireless

PSoC[®] Solutions

PSoC 1 | PSoC 3 | PSoC 4 | PSoC 5LP | PSoC 6

Cypress Developer Community

Forums | WICED IOT Forums | Projects | Video | Blogs | Training | Components

Technical Support

cypress.com/support

© Cypress Semiconductor Corporation, 2013-2017. This document is the property of Cypress Semiconductor Corporation and its subsidiaries, including Spansion LLC ("Cypress"). This document, including any software or firmware included or referenced in this document ("Software"), is owned by Cypress under the intellectual property laws and treaties of the United States and other countries worldwide. Cypress reserves all rights under such laws and treaties and does not, except as specifically stated in this paragraph, grant any license under its patents, copyrights, trademarks, or other intellectual property rights. If the Software is not accompanied by a license agreement and you do not otherwise have a written agreement with Cypress governing the use of the Software, then Cypress hereby grants you a personal, non-exclusive, nontransferable license (without the right to sublicense) (1) under its copyright rights in the Software (a) for Software provided in source code form, to modify and reproduce the Software solely for use with Cypress hardware products, only internally within your organization, and (b) to distribute the Software in binary code form externally to end users (either directly or indirectly through resellers and distributors), solely for use on Cypress hardware product units, and (2) under those claims of Cypress's patents that are infinged by the Software (as provided by Cypress, unmodified) to make, use, distribute, and import the Software solely for use with Cypress hardware products. Any other use, reproduction, modification, translation, or compilation of the Software is prohibited.

TO THE EXTENT PERMITTED BY APPLICABLE LAW, CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS DOCUMENT OR ANY SOFTWARE OR ACCOMPANYING HARDWARE, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. To the extent permitted by applicable law, Cypress reserves the right to make changes to this document without further notice. Cypress does not assume any liability arising out of the application or use of any product or circuit described in this document. Any information provided in this document, including any sample design information or programming code, is provided only for reference purposes. It is the responsibility of the user of this document to properly design, program, and test the functionality and safety of any application made of this information and any resulting product. Cypress products are not designed, intended, or authorized for use as critical components in systems designed or intended for the operation of weapons, weapons systems, nuclear installations, life-support devices or systems, other medical devices or systems (including resuscitation equipment and surgical implants), pollution control or hazardous substances management, or other uses where the failure of the device or system could cause personal injury, death, or properly damage ("Unintended Uses"). A critical component is any component of a device or system whose failure to perform can be reasonably expected to cause the failure of the device or system, or to affect its safety or effectiveness. Cypress is not liable, in whole or in part, and you shall and hereby do release Cypress from any claim, damage, or other liability arising from or related to all Unintended Uses of Cypress products.

Cypress, the Cypress logo, Spansion, the Spansion logo, and combinations thereof, WICED, PSoC, CapSense, EZ-USB, F-RAM, and Traveo are trademarks or registered trademarks of Cypress in the United States and other countries. For a more complete list of Cypress trademarks, visit cypress.com. Other names and brands may be claimed as property of their respective owners.